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Docket No.: P0370US-7

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: NAKAMURA et al.

Examiner: Unknown

Serial No.: 10/848,937

Art Unit: 2828

Filing Date: May 18, 2004

For: METHOD FOR FABRICATING GROUP-III NITRIDE DEVICES AND DEVICES
FABRICATED USING METHOD

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450


REQUEST FOR A CORRECTED FILING RECEIPT

Sir:

Transmitted herewith is a request for a corrected filing receipt. As noted on the enclosed filing receipt, the title is incorrectly listed as: METHOD FOR FABRICATING THIN FILM SEMICONDUCTOR DEVICES AND DEVICES FABRICATED USING METHOD. Please correct the filing receipt to reflect the title to: METHOD FOR FABRICATING GROUP-III NITRIDE DEVICES AND DEVICES FABRICATED USING METHOD.

Respectfully submitted,

October 13, 2005


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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service via Express mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

Date

10/21/05 
Mariana M. Rivas



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2005 APP. NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/18/04 48,937	05/18/2004	2828	1360	P0370US-7	7	48	4

CONFIRMATION NO. 5701

FILING RECEIPT



OC000000013268781

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JUL 20

KOPPEL, JACOBS, PATRICK & HEYBL

Date Mailed: 07/20/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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CALENDAR ENTRY

ACTION IDS
CALENDAR FOR 8/18/04

Assignment For Published Patent Application

CREE, INC.;

CALENDAR ENTRY

ACTION Convention Date
CALENDAR FOR 6/18/05

Domestic Priority data as claimed by applicant

Foreign Applications

CALENDAR ENTRY

ACTION ck App. Status
CALENDAR FOR 11/18/05

If Required, Foreign Filing License Granted: 07/19/2004

Projected Publication Date: To Be Determined - pending completion of Corrected Papers

Non-Publication Request: No

Early Publication Request: No

Title

~~Method for fabricating thin film semiconductor devices and devices fabricated using method~~

Preliminary Class

372

METHOD FOR FABRICATING GROUP-III NITRIDE DEVICES
AND DEVICES FABRICATED USING METHOD

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Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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